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July 2014

# FDFMA2P029Z

## Integrated P-Channel PowerTrench<sup>®</sup> MOSFET and Schottky Diode

-20V, -3.1A, 95mΩ

### Features

#### MOSFET

- Max  $r_{DS(on)}$  = 95mΩ at  $V_{GS} = -4.5V$ ,  $I_D = -3.1A$
- Max  $r_{DS(on)}$  = 141mΩ at  $V_{GS} = -2.5V$ ,  $I_D = -2.5A$
- HBM ESD protection level > 2.5kV (Note 3)

#### Schottky

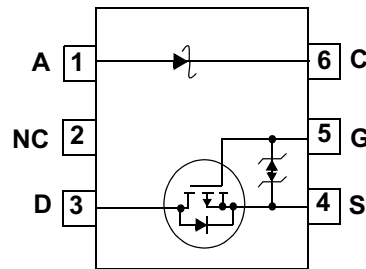
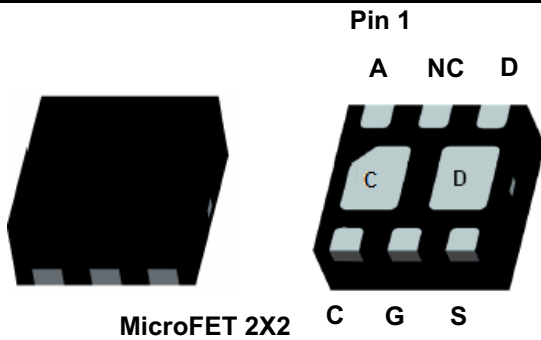
- $V_F < 0.37V$  @ 500mA
- Low profile - 0.8 mm maximum - in the new package  
MicroFET 2x2 mm
- RoHS Compliant



### General Description

This device is designed specifically as a single package solution for the battery charge switch in cellular handset and other ultra-portable applications. It features a MOSFET with very low on-state resistance and an independently connected low forward voltage schottky diode allows for minimum conduction losses.

The MicroFET 2X2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.



### MOSFET Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Ratings	Units
$V_{DS}$	Drain to Source Voltage	-20	V
$V_{GS}$	Gate to Source Voltage	±12	V
$I_D$	Drain Current -Continuous	(Note 1a) -3.1	A
	-Pulsed	-6	
$P_D$	Power Dissipation	(Note 1a) 1.4	W
		(Note 1b) 0.7	
$T_J, T_{STG}$	Operating and Storage Junction Temperature Range	-55 to +150	°C
$V_{RRM}$	Schottky Repetitive Peak Reverse Voltage	20	V
$I_O$	Schottky Average Forward Current	2	A

### Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	86	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	173	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1c)	86	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1d)	140	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.P29	FDFMA2P029Z	MicroFET 2X2	7"	8mm	3000 units

## Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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### Off Characteristics

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = -250\mu\text{A}, V_{GS} = 0\text{V}$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$ , referenced to $25^\circ\text{C}$		-12		mV/°C
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -16\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS} = \pm 12\text{V}, V_{DS} = 0\text{V}$			$\pm 10$	$\mu\text{A}$

### On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$	-0.6	-1.0	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu\text{A}$ , referenced to $25^\circ\text{C}$		4		mV/°C
$r_{DS(on)}$	Static Drain to Source On-Resistance	$V_{GS} = -4.5\text{V}, I_D = -3.1\text{A}$		60	95	m $\Omega$
		$V_{GS} = -2.5\text{V}, I_D = -2.5\text{A}$		88	141	
		$V_{GS} = -4.5\text{V}, I_D = -3.1\text{A}, T_J = 125^\circ\text{C}$		87	140	
$g_{FS}$	Forward Transconductance	$V_{DS} = -10\text{V}, I_D = -3.1\text{A}$		-11		S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = -10\text{V}, V_{GS} = 0\text{V},$ $f = 1\text{MHz}$		540	720	pF
$C_{oss}$	Output Capacitance			120	160	pF
$C_{rss}$	Reverse Transfer Capacitance			100	150	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = -10\text{V}, I_D = -1\text{A}$ $V_{GS} = -4.5\text{V}, R_{GEN} = 6\Omega$		13	24	ns
$t_r$	Rise Time			11	20	ns
$t_{d(off)}$	Turn-Off Delay Time			37	59	ns
$t_f$	Fall Time			36	58	ns
$Q_{g(TOT)}$	Total Gate Charge		$V_{DD} = -10\text{V}, I_D = -3.1\text{A}$		7	10
$Q_{gs}$	Gate to Source Gate Charge	$V_{GS} = -4.5\text{V}$		1.1		nC
$Q_{gd}$	Gate to Drain "Miller" Charge			2.4		nC

### Drain-Source Diode Characteristics

$I_S$	Maximum Continuous Drain-Source Diode Forward Current				-1.1	A
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = -1.1\text{A}$ (Note 2)		-0.8	-1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F = -3.1\text{A}, di/dt = 100\text{A}/\mu\text{s}$		25		ns
$Q_{rr}$	Reverse Recovery Charge			9		nC

### Schottky Diode Characteristics

$V_R$	Reverse Voltage	$I_R = 1\text{mA}$	$T_J = 25^\circ\text{C}$	20			V
$I_R$	Reverse Leakage	$V_R = 20\text{V}$	$T_J = 25^\circ\text{C}$		30	300	$\mu\text{A}$
			$T_J = 125^\circ\text{C}$		10	45	mA
$V_F$	Forward Voltage	$I_F = 500\text{mA}$	$T_J = 25^\circ\text{C}$		0.32	0.37	V
			$T_J = 125^\circ\text{C}$		0.21	0.26	
		$I_F = 1\text{A}$	$T_J = 25^\circ\text{C}$		0.37	0.435	
			$T_J = 125^\circ\text{C}$		0.28	0.33	

**Notes:**

1:  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta JA}$  is determined by the user's board design.

(a) MOSFET  $R_{\theta JA}$  = 86°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB

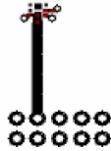
(b) MOSFET  $R_{\theta JA}$  = 173°C/W when mounted on a minimum pad of 2 oz copper

(c) Schottky  $R_{\theta JA}$  = 86°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper, 1.5" x 1.5" x 0.062" thick PCB.

(d) Schottky  $R_{\theta JA}$  = 140°C/W when mounted on a minimum pad of 2 oz copper.



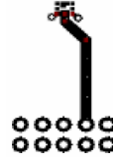
a) 86°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper.



b) 173°C/W when mounted on a minimum pad of 2 oz copper.



c) 86°C/W when mounted on a 1in<sup>2</sup> pad of 2 oz copper.

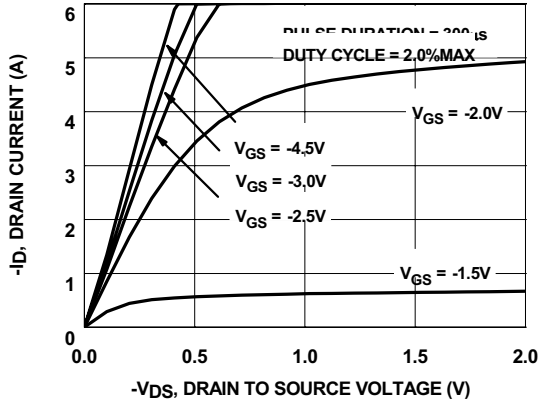


d) 140°C/W when mounted on a minimum pad of 2 oz copper.

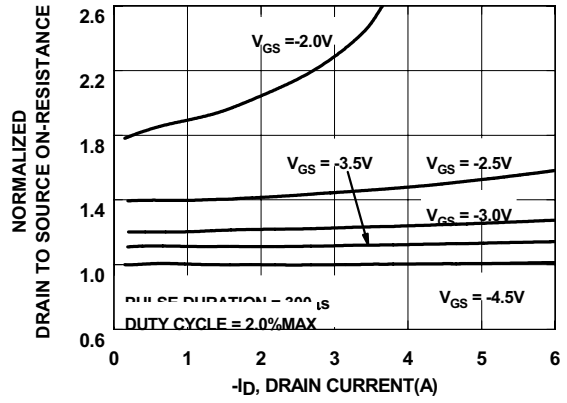
2: Pulse Test : Pulse Width < 300us, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only protection against ESD. No gate overvoltage rating is implied.

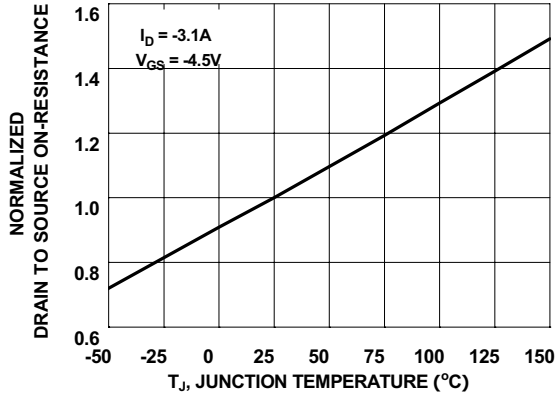
**Typical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted



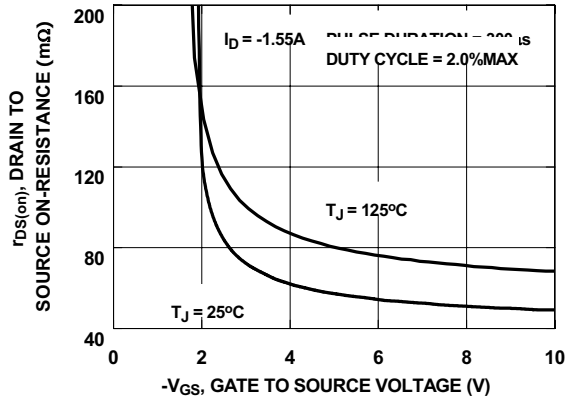
**Figure 1. On Region Characteristics**



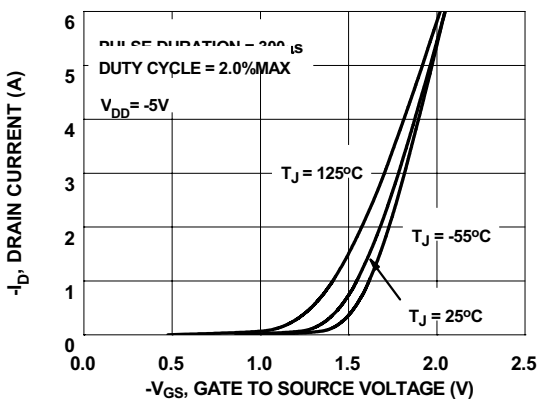
**Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage**



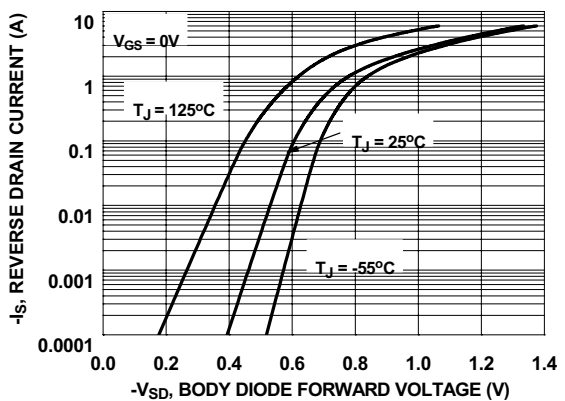
**Figure 3. Normalized On-Resistance vs Junction Temperature**



**Figure 4. On-Resistance vs Gate to Source Voltage**

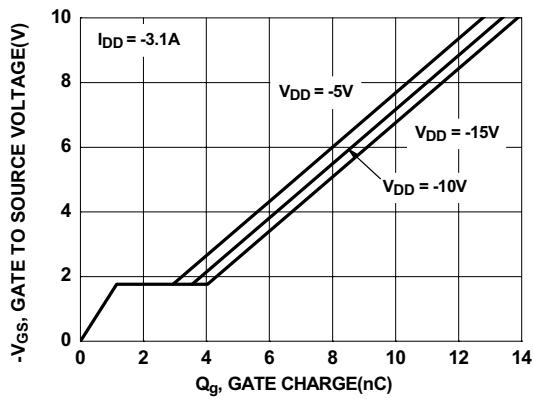


**Figure 5. Transfer Characteristics**

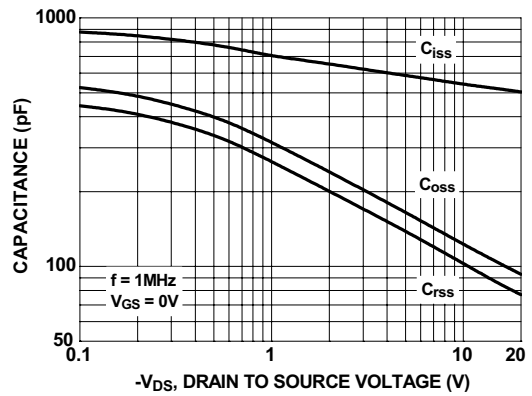


**Figure 6. Source to Drain Diode Forward Voltage vs Source Current**

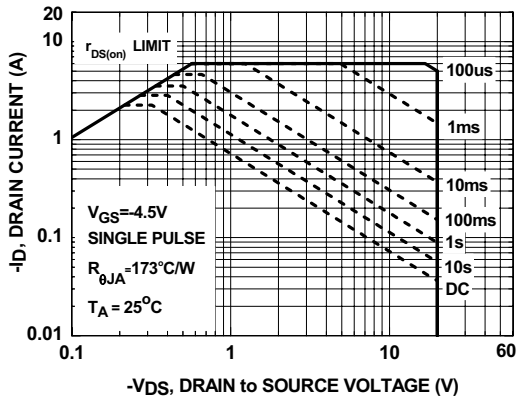
**Typical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted



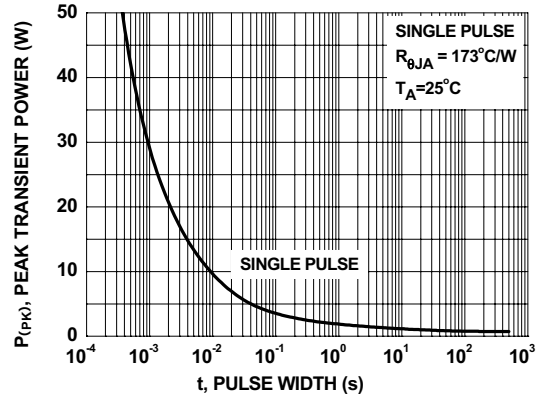
**Figure 7. Gate Charge Characteristics**



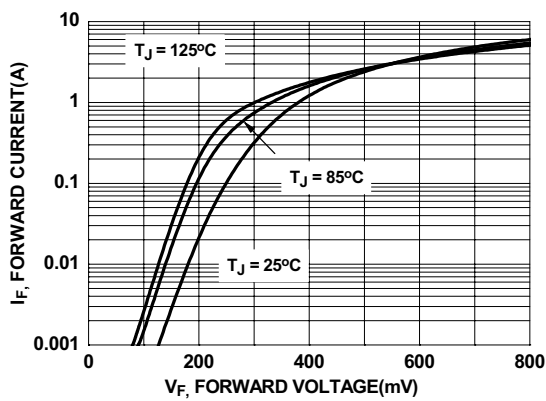
**Figure 8. Capacitance Characteristics**



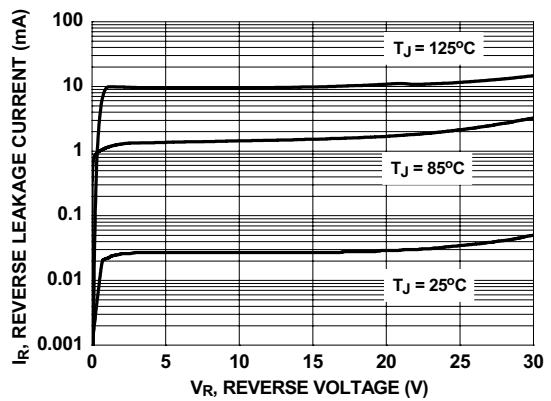
**Figure 9. Forward Bias Safe Operating Area**



**Figure 10. Single Pulse Maximum Power Dissipation**

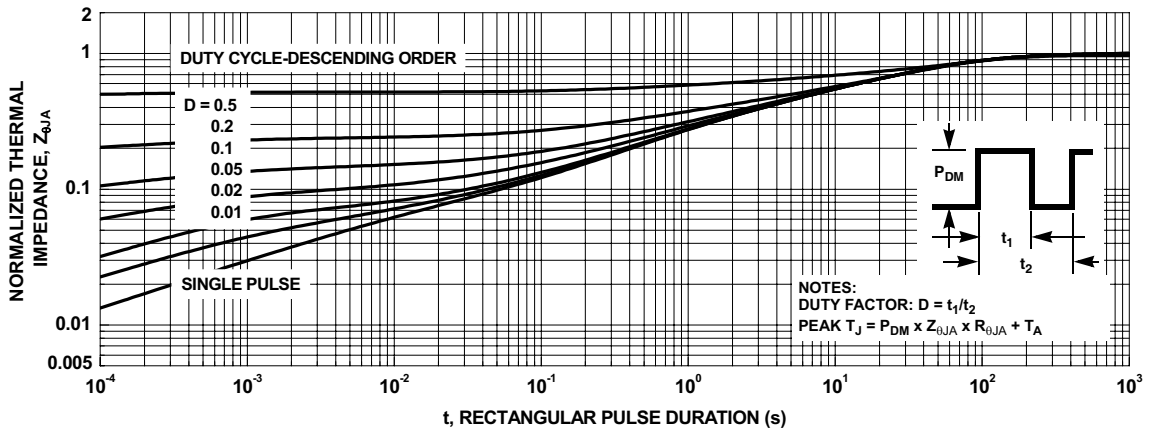


**Figure 11. Schottky Diode Forward Voltage**

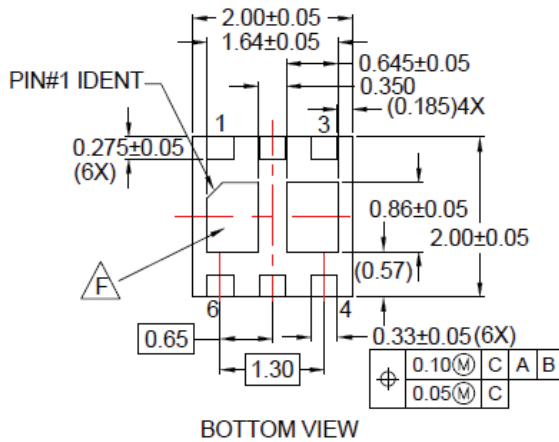
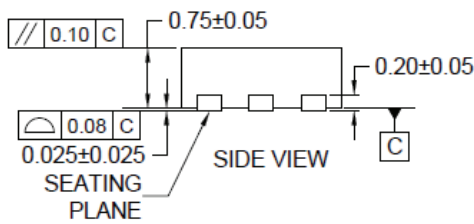
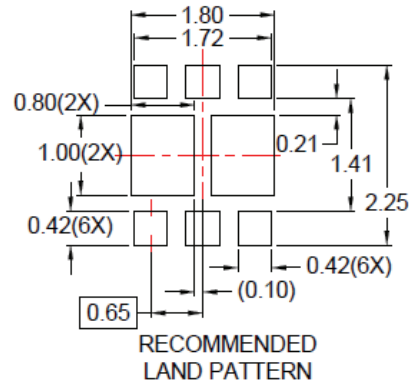
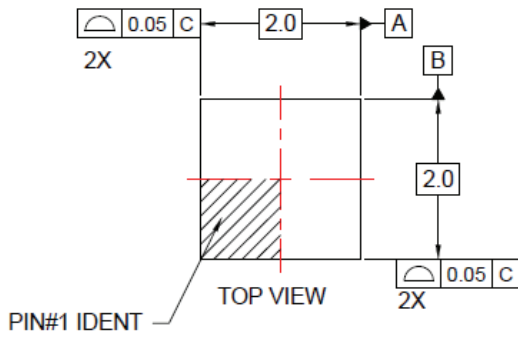


**Figure 12. Schottky Diode Reverse Current**

**Typical Characteristics**  $T_J = 25^\circ\text{C}$  unless otherwise noted



## Dimensional Outline and Pad Layout



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- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
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## Стандарт Электрон Связь

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

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